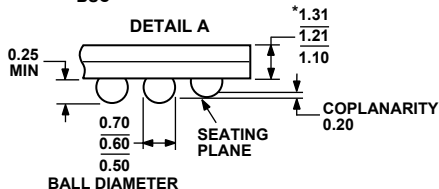
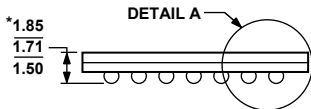
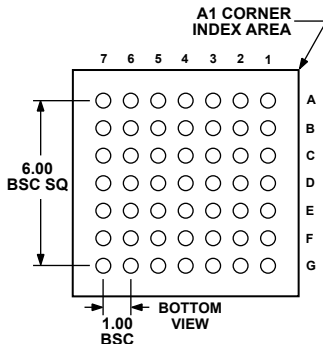
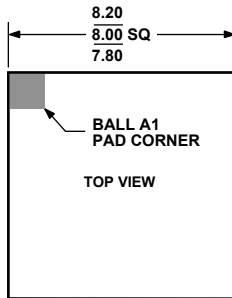


49-Ball Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-49-3)

Dimensions shown in millimeters

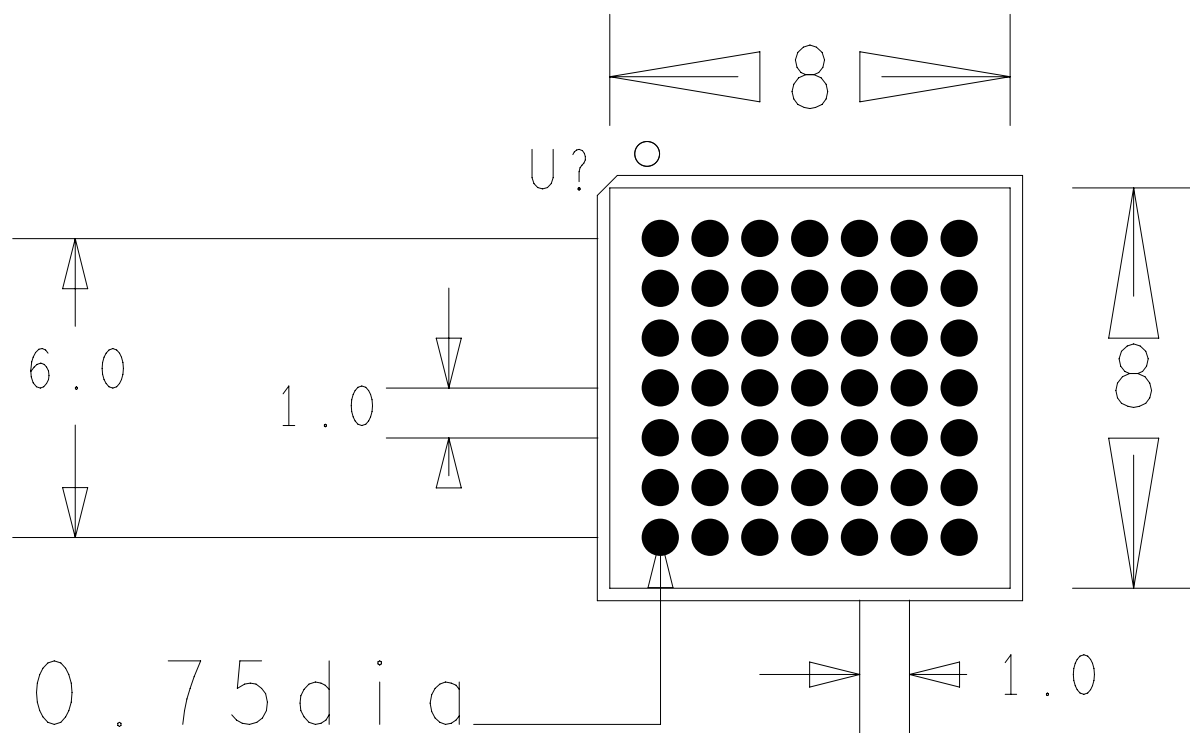


*COMPLIANT WITH JEDEC STANDARDS MO-192-ABB-1
WITH EXCEPTION TO PACKAGE HEIGHT AND THICKNESS.

Analog Devices

BC - 49

REV A



(Dim. are in MM)

LAST MODIFIED 08/29/07